

# Triacs Sillicon Bidirectional Thyristors

### TRIACS 16 AMPERES RMS 600 VOLTS

**TO-220AB** 

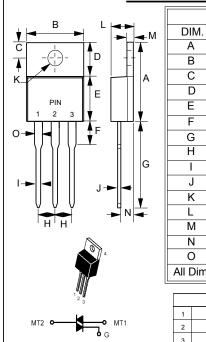
#### **FEATURES**

- Minimizes Snubber Networks for Protection
- Blocking Voltage to 600 Volts
- On-State Current Rating of 16 Amperes RMS High Surge Current Capability — 150 Amperes
- Glass Passivated Junctions for Reliability and Uniformity Operational in Three Quadrants, Q1, Q2, and Q3
- Pb Free Package

#### **MECHANICAL DATA**

• Case: Molded plastic

• Weight: 0.07 ounces, 2.0 grams



TO-220AB						
DIM.	MIN.	MAX.				
Α	14.22	15.88				
В	9.65	10.67				
С	2.54	3.43				
D	5.84	6.86				
Е	8.26	9.28				
F	-	6.35				
G	12.70	14.73				
Н	2.29	2.79				
l	0.51	1.14				
J	0.40	0.67				
K	3.53Ø	4.09 ∅				
L	3.56	4.83				
М	1.14	1.40				
N	2.03	2.92				
0	1.17	1.37				
All Dimensions in millimeter						

	PIN ASSIGNMENT
1	Main Terminal 1
2	Main Terminal 2
3	Gate
4	Main Terminal 2

#### MAXIMUM RATINGS (Tj= 25° unless otherwise noticed)

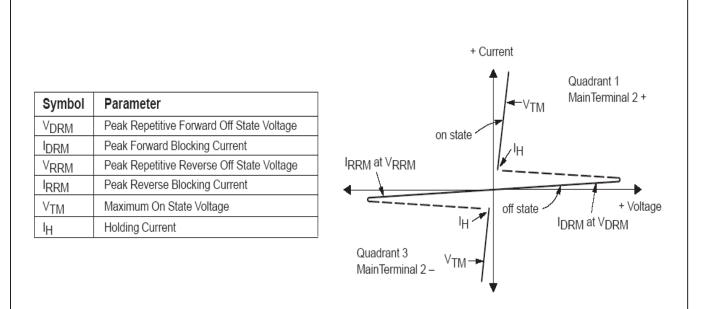
Rating		l Value	Unit
Peak Repetitive Off– State Voltage (1) (TJ= -40 to 125°C, Sine Wave, 50 to 60 Hz; Gate Open)	VDRM, VRRM	600	Volts
On-State RMS Current (Tc = +80℃) Full Cycle Sine Wave 50 to 60 Hz	IT(RMS)	16	Amp
Peak Non-Repetitive Surge Current (One Full Cycle Sine Wave, 60 Hz, TJ= 25℃) Preceded and followed by rated current.	Ітѕм	150	Amps
Circuit Fusing Consideration (t = 8.3 ms)	l t	93	A <sup>2</sup> s
Peak Gate Power (Tc = +80°C, Tp≦ 1.0 us)	Рсм	20	Watt
Average Gate Power (Tc = +80℃, t=8.3 ms)		0.5	Watt
Operating Junction Temperature Range		-40 to +125	°C
Storage Temperature Range	Tstg	-40 to +150	°C
Nation: (1) Venu and Venu for all types can be applied an a centinuous basis. Placking	RI	=V 4 Oct_2010 KT	TXC21

Notice: (1) VDRM and VRRM for all types can be applied on a continuous basis. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

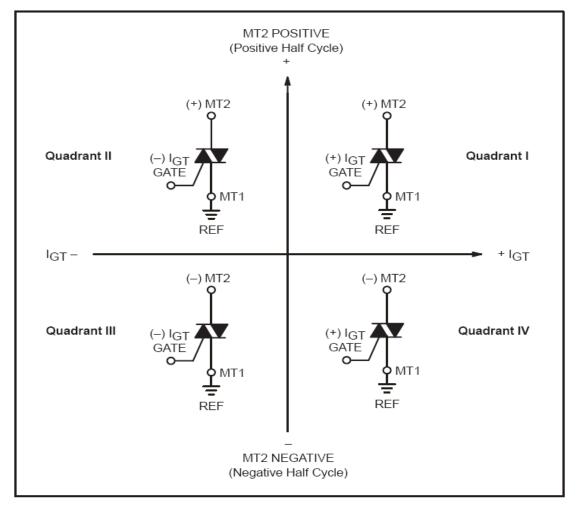


Characteristic  Thermal Resistance - Junction to Case - Junction to Ambient  Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds				2.0 62.5 260	°C/W						
						ELECTRICAL CHARACTERISTICS (TJ=25°C unless other	rwise noted, E	Electrical	apply in b	oth direct	ions)
						Characteristics	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS											
Peak Reptitive Forward or Reverse Blocking Current TJ=25℃ (VD=Rated VDRM, VRRM; Gate Open) TJ=125℃	IDRM IRRM			0.01 2.0	mA						
ON CHARACTERISTICS	1										
Peak On-State Voltage (ITM= $\pm$ 21 A Peak @Tp $\leq$ 2.0 ms, Duty Cycle $\leq$ 2%)	Vтм		1.2	1.6	Volts						
Gate Trigger Current (V <sub>D</sub> = 12Vdc; R <sub>L</sub> = 100 Ohms)	IGT1 IGT2 IGT3	5.0 5.0 5.0	12 16 20	35 35 35	mA						
Gate Trigger Voltage (V <sub>D</sub> = 12 Vdc; R <sub>L</sub> =100 Ohms)	VGT1 VGT2 VGT3	0.5 0.5 0.5	0.75 0.72 0.82	1.5 1.5 1.5	Volts						
Holding Current (V <sub>D</sub> = 12 V, Initiating Current = ± 150 mA, Gate Open)	Тн		20	50	mA						
Latching Current (VD = 12 V, IG = 35 mA)	IL		25 40 24	50 80 50	mA						
DYNAMIC CHARACTERISTICS											
Critical Rate of Change of Commutation Current VD = Rated VDRM, ITM = 6.0 A, Commutating dv/dt = 24 V/ms, Gate Jnenergized,Tc = 125°C,f = 250 Hz,Snubber: CL = 10 uf, LL =40 mH)	di/dt(c)	15			A/ms						
Critical Rate of Rise of Commutation Voltage VD = 67% VDRM , Exponential Waveform, Tc = 125℃)	dv/dt	600			V/us						
Repettive Critical Rate of Rise of On-State Current IPK= 50A, PW=40 us; diG/dt = 200mA/us; f =60Hz	di/dt			10	A/us						



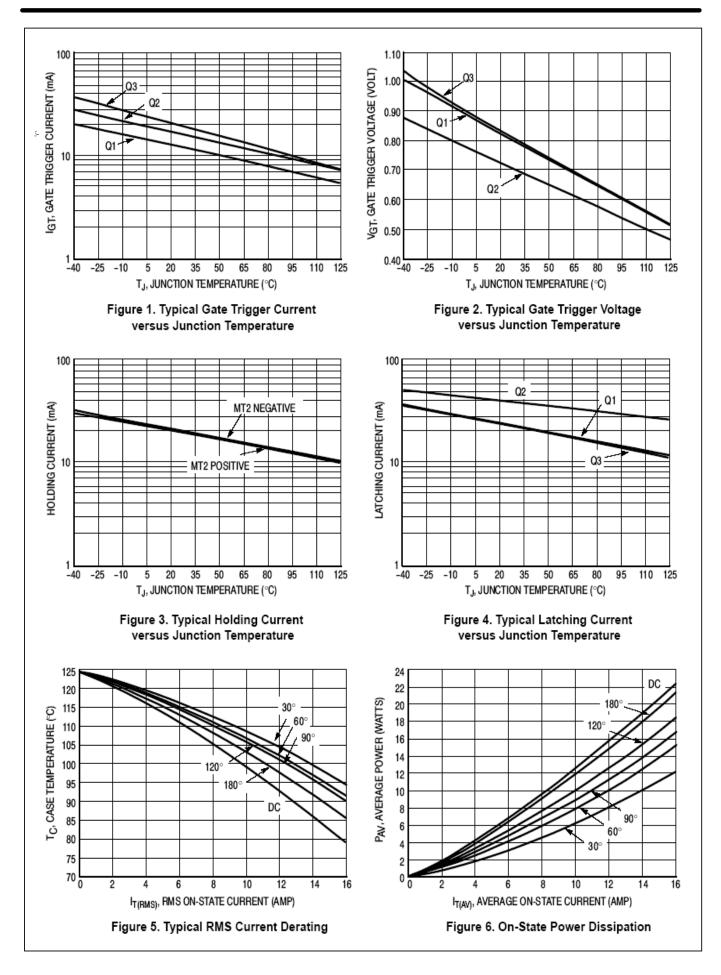


# **Quadrant Definitions**



All polarities are referenced to MT1 Whith in -phase signal (using standard AC lines) quadrants I and III are used







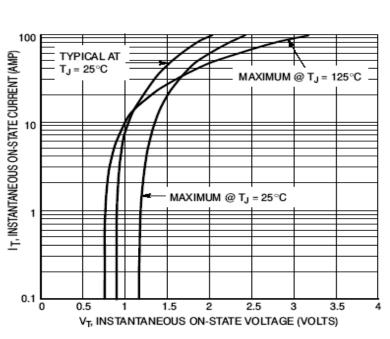


Figure 7. On-State Characteristics

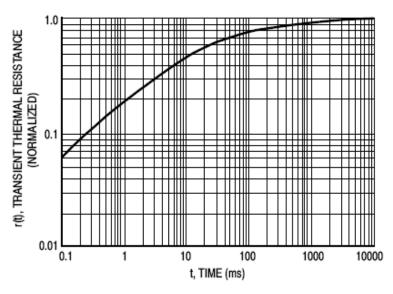


Figure 8. Typical Thermal Response



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